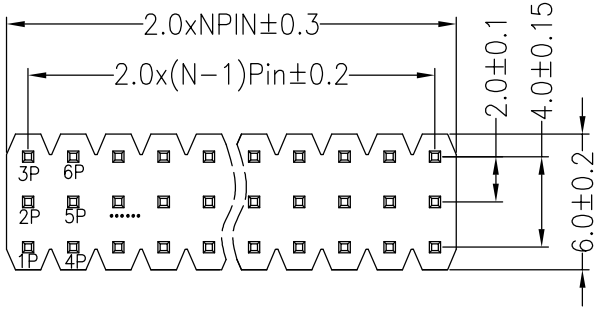
HSF RoHS

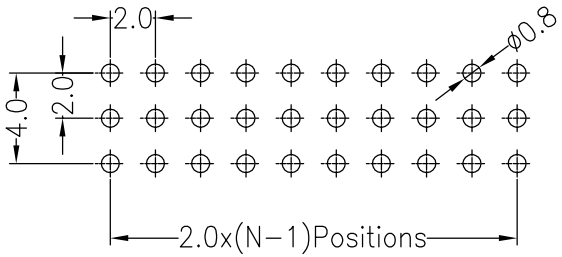
FILE NO :E362810

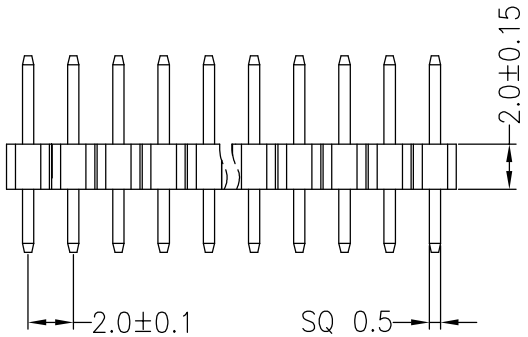
SPECIFICATIONS
Rated Current:1.5AMP
Contact Resistance:20mΩ Max
Withstand Voltage:500V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

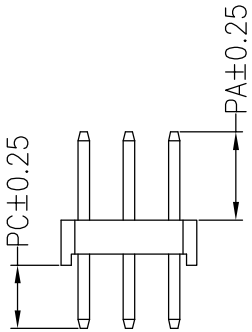
Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 5 seconds)



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)







Ordering Information

1320 13 XX X N XX S XXX X 0X

- No.of Pins Per Row: 2~40
- Insulator Material Option: A=BK−PBT; C=BK−PA6T; D=BK−PA46; E=BK−PA9T; F=BK−LCP
- Contact Plating: G0:Gold Flash; G1:1U" Gold; G2:1.5U" Gold; G3:2U" Gold; G4:3U" Gold; G5:5U" Gold; G6:10U" Gold; G7:15U" Gold; S0:Gold Flash/Tin; SN:Tin
- Pin Length
- Post: A=Tray; T=Tube; 0=Pe; R=Tape&ReeL; P=Tube&ReeL

Dimension antitheses list		
ITEM	PA	PC
Standard	3.90	2.80

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2018.04.11	NEW DRAWING	

OPERATION		DRAW	Liu Miao	18.04.11	SCALE	FIT
X.X	±0.30				UNIT	mm
X.XX	±0.20	CHECK			SIZE	A4
X.XXX	±0.10				SHEET	1/1
Angle	±3°	APPROVE			PROJ.	
DIM	TOL					

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	132013XXXNXXSXXXX0X
TITLE:	2.0PH 3xNpin H2.0mm 180°